



Annex B2 - Product environmental attributes Servers/Data Storage Products

The declaration may be published only when all rows and/or fields marked with * are filled-in (N/A for not applicable). Additional information regarding each item may be found under P15.

Brand *	Lenovo	Logo				
Company name *	Lenovo	1				
Contact information *	Lenovo Global Environmental Affairs	1	Lenovo			
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	http://www.lenovo.com/ecodeclaration					

The company declares (based on product specification or test results based obtained from sample testing), that the product conforms to the statements given in this declaration.						
Type of product *	Type of product * Server					
Commercial name *	ThinkSystem SD650-N V3 Neptune DWC Tray					
Model number *	7D7N					
Issue date *	Feb 27, 2024					
Intended market *	☐ Global ☐ Europe ☐ Asia, Pacific & Japan ☐ Americas ☐ Other					
Additional information						

This is an uncontrolled copy when in printed form. Please refer to the contact information for the latest version.

About Annex B2

Annex B2 reflects Product environmental attributes relevant for Computers and Computer Monitors. The following items from the ECMA-370 Main body are not shown in the template:

P4.1 – P4.3 Consumable materials

P9.1 TEC and Print speed

P10.2 - P10.3 Chemical emissions from printing products

P11.1 - P11.3 Consumable materials for printing products.

Model number *		7D7N	Logo	Lend)V(C	
Issue date *		Feb 27, 2024		Len		тн
Product en	vironr	nental attributes - Legal requirements		Require	ment	
Item				Yes	No	N/A
		us substances and preparations				
		do comply with current European RoHS Directive. (See legal reference and NOTE	E B1)			
С	ommen	do not contain Asbestos (see legal reference). t: Legal reference has no maximum concentration value.				
hy	Products do not contain Ozone Depleting Substances: Chlorofluorocarbons (CFC), hydrobromofluorocarbons (HBFC), hydrochlorofluorcarbons (HCFC), Halons, carbontetrachloride, 1,1,1- trichloroethane, methyl bromide (see legal reference). Comment: Legal reference has no maximum					
	concentration values.					
	roducts erphenyl	lorinated				
		do not contain more than 0,1% short chain chloroparaffins (SCCP) with 10-13 carl taining at least 48% per mass of chlorine in the SCCP (see legal reference).	bon atoms in t	the 🔀		
(s	see lega	n direct and prolonged skin contact do not release nickel in concentrations above (I reference). t: Max limit in legal reference when tested according to EN1811:2011-5.),5 μg/cm²/we	ek 🔀		
P1.7* R	EACH A	Article 33 information about substances in articles is available at (add URL or mail www.lenovo.com/us/en/Lenovo-REACH-SVHC-Disclosure	contact):			
P2 B	atteries					
		duct contains a battery or an accumulator, the battery/accumulator is labeled with nformation on proper disposal is provided in user manual. (See legal reference)	the disposal			
	atteries eference	or accumulators do not contain more than 0,0005% of mercury or 0,002% of cadn	nium. (See leg	jal 🔀		
P2.3* B	atterie	es and accumulators are readily removable. (See legal reference)	\boxtimes		
		entation includes the number of cycles the (secondary) battery ca gal reference)	an withstar	ıd.		
b; p	y a no ackagi	nternal batteries of a notebook computer cannot be "accessed ar nprofessional user", the related text is present and legible on th ing (See legal reference)				
	onform	ity verification & Eco design (ErP)				
TI <u>h</u>	he Decl <u>ttps://w</u>	uct is CE-marked to show conformance with applicable legal requirements (see legal requirements): aration of Conformity can be requested at (add link or e-mail address): aww.lenovo.com/us/en/compliance/eu-doc for EU aww.lenovo.com/us/en/compliance/uk-doc for UK	gal reference)	. 🔲		
P3.2* TI	he prod	uct complies with the applicable Eco design requirements for energy-related produ al reference)	ıcts,			
,	•	information is; Significantly given in item P15 or added to this document, available at (add URL): http://www.lenovo.com/ecode	alawatia w			
P5 P	roduct	packaging	<u>CidiauOII</u>			
		g and packaging components do not contain more than 0,01% lead, mercur	v cadmium a	and 🔀		
	Packaging and packaging components do not contain more than 0,01% lead, mercury, cadmium an hexavalent chromium by weight of these together					
P5.2* TI	he pack	aging materials are marked with abbreviations and numbers indicating the nature elegal reference)	of the materia	l(s)		
Р	rotocol (uct packaging material is free from ozone depleting substances as specified in the (See legal reference) t: Legal reference has no maximum concentration values	Montreal			
		nt information				
P6.1* In	formatic	on for recyclers/treatment facilities is available (https://lenovo.com/recycling).		\boxtimes		

NOTE B1 Restriction applies to the homogeneous material, unless other specified and expressed in weight %. Stating "Yes" means that the product is compliant with the mandatory requirements.

Issue date Feb 27, 2024 Product environmental attributes - Market requirements (See General NOTE GN below)	wodel number *		7D7N	Logo	Len	N/O	
Comparison Com	Issue dat	te *	Feb 27, 2024		Len		тн
P7.1 Parts that have to be treated separately are easily separable P7.2 Plastic materials in covers/housing have no surface coating. P7.3 Plastic parts > 25 plastic parts par		- Enviro	nmental conscious design	,			
P7.1 Parts that have to be treated separately are easily separable P7.2 Plastic materials in covers/housing have no surface coating. P7.3 Plastic parts > 100 g consist of one material or of easily separable materials. P7.4 Plastic parts > 25 g have material codes according to ISO 11469 referring ISO 1043-4. P7.5 Plastic parts are free from metal inlays or have inlays that can be removed with commonly available tools. P7.6 Labels are easily separable. (This requirement does not apply to safety/regulatory labels). P7.7 Service is available after end of production for: P7.7 P7.					Yes	No	N/A
P7.2* Plastic materials in covers/housing have no surface coating. P7.3* Plastic parts > 100 g consist of one material or of easily separable materials. P7.4* Plastic parts > 25 g have material codes according to ISO 11469 referring ISO 1043-4. P7.5* Plastic parts > 25 g pare hat pare to according ISO 1043-4. P7.5* Plastic parts are free from metal inlays or have inlays that can be removed with commonly available tools. P7.6* Labels are easily separable. (This requirement does not apply to safety/regulatory labels). P7.6* Product lifetime P7.7* Upgrading can be done e.g. with processor, memory, cards or drives P7.8* Upgrading can be done using commonly available tools P7.9* Spare parts are available after end of production for: years P7.10* Service is available after end of production for: years P7.11* Product cover/housing material bye (e.g. plastics, metal, aluminum): Material type: SOC Material type: SUS Material type: PC+ABS Material type: SOC Material type: SUS Material type: PC+ABS Insulation materials of internal electrical cables are PVC free. P7.13* Insulation materials of internal electrical cables are PVC free. P7.14* External plastic casing/cover parts > 25 g contain no more than 0.1% weight (1000 ppm) chlorine attributable to brominated flame retardants, chlorinated flame retardants, and polyviny chloride or 0.3% weight (3000 ppm) chlorine and 0.3% weight (3000 ppm) chlorine in parts containing more than 25% post-consumer recycled content. Printed circuit boards, PCBs (without components) are low halogen: as defined in IEC 61249-2.21. (See *NOTE B2) PR.2*							
P7.3* Plastic parts > 100 g consist of one material or of easily separable materials. P7.4* Plastic parts > 25 g have material codes according to ISO 11469 referring ISO 1043-4. P7.5* Plastic parts are fee from metal inlays or have inlays that can be removed with commonly available tools. P7.6* Labels are easily separable. (This requirement does not apply to safety/regulatory labels). P7.7* Upgrading can be done e.g. with processor, memory, cards or drives P7.7* Upgrading can be done e.g. with processor, memory, cards or drives P7.8* Upgrading can be done using commonly available tools P7.9 Spare parts are available after end of production for: years Material and substance requirements P7.10* Service is available after end of production for: years Material and substance requirements P7.11* Material and substance requirements P7.12* Insulation materials of external electrical cables are PVC free. P7.13 Insulation materials of internal electrical cables are PVC free. P7.14* External plastic casing/cover parts > 25 g contain no more than 0.1% weight (1000 ppm) bromine and 0.1% weight (1000 ppm) chlorine attributable to brominated filame retardants, chlorinated filame retardants, and polywiny chloride or 0.3% weight (3000 ppm) bromine and 0.3% we			<u> </u>				4
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TBBPA (additive), TBBPA (reactive) (See NOTE B3), Other: chemical name:, CAS #:	P7.16		tarded plastic parts > 25 g in covers / housings are marked according ISO 1043-4:				
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P7.19 In plastic parts > 25 g, flame retardant substances/preparations above 0,1% are used which have been assigned the following Risk phrases; and Hazard statements: The source(s) for these classifications is/are found at (add URL(s)): P7.20* Postconsumer recycled plastic material content is used in the product (See Note B6): If YES; at least one of the two alternatives below shall be answered; a) Of total plastic parts' weight > 25 g, the postconsumer recycled plastic material content (calculated as a percentage of total plastic by weight) is or	P7.18	concentr 1. Chem 2. Chem	ations above 0,1%: cal name: , CAS #: (See NOTE B4) cal name: , CAS #: "	s/preparations ir			
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P7.20* Postconsumer recycled plastic material content is used in the product (See Note B6): If YES; at least one of the two alternatives below shall be answered; a) Of total plastic parts' weight > 25 g, the postconsumer recycled plastic material content (calculated as a percentage of total plastic by weight) is or	P7.19	assigned	the following Risk phrases; and Hazard statements:				
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, , ,		If YES; a a) Of t a pe or	t least one of the two alternatives below shall be answered; otal plastic parts' weight > 25 g, the postconsumer recycled plastic material contenercentage of total plastic by weight) is %.	it (calculated as			

GENERAL NOTE Standard references should direct to the latest version of a standard. If an older version of a standard is used, section P15 shall be used for explanation.

NOTE B2 IEC 61249-2-21 defines maximum limits of 900 ppm for each of the substances chlorine and bromine and a maximum limit of 1500ppm of these substances combined. The standard does not address fluorine, iodine and astatine which are included in the group of halogens.

NOTE B3 and B4 A Guidance document on Chemical substances is available; see http://www.ecma-international.org/publications/standards/Ecma-370.htm.

NOTE B5 If a certain substance has been assigned a certain risk phrases / hazard statement in the referenced source, this does not necessarily mean the substance has been tested for all of the hazards referred to by a certain customer.

NOTE B6 Applies to a product containing plastic parts whose combined weight exceeds 100 g with the exception of printed circuit boards, cables, connectors and electronic components and bio-based plastic material.

Model number *	7D7N	Logo	Lenovo		
Issue date *	Feb 27, 2024		Len		TH.
Product environr	nental attributes - Market requirements (continued)		Requir	emen	t met
Item			Yes	No	N/A

P7.21*	Material and substance requirements (continued) Biobased plastic material content is used in the product (See NOTE B7):							
1 7.21	If YES; at least o	ne of the two alternative tic parts' weight > 25 g,	s below shall be answe	red;	ted as a percentage of	Ш		
		by weight) is %.	ano anoadou praduo mi		iou uo u porociniago o			
	b) The weight	of the biobased plastic n	naterial is g.					
P7.22*	U	e free from mercury, i.e. d d specify: Number of lan	, , ,	ım mercury content pe	r lamp: mg			
P7.23*	If product include	es an integral display, the	total mercury content	in the integrated displa	ay: mg			\boxtimes
P8	Batteries							
P8.1*	Battery chemical composition: Lithium Manganese Dioxide							
P9		ption (See NOTE B8)						
P9.1		he following power levels			In ((0))			
Energy mod		Power level at 100 V AC	Power level at 115 V AC	Power level at 230 V AC	Reference/Standard modes and test method		ergy	
Peak (On-r	nax)	W	W	W	Full load			
Category	<u>/</u>							
EPS No-loa		W	W	W				
	ower supply /							
	charger plugged in the wall							
the product	isconnected from							
PTEC *	.)	W	W	W				
Typical Energy Consumption		V V	VV	VV				\boxtimes
ETEC *	ergy Consumption	kWh/year	kWh/year	kWh/year				
		ency Level (International	Efficiency Marking Pro	tocal) * ·				\square
Display res		negapixels	Emolericy Manang 1 10					
	to enter energy	save mode: minut	es					
P9.2*	Information about	t the energy save function	on is provided with the t	product		X	$\overline{\Box}$	
P9.3		class (monitors only):	promada marand				<u> </u>	
		Glass (Monitors Grily).						
P10	Emissions	 Declared according to 	ISO 0206 (See NOTE	R0)				
P10.1	Mode	Mode description	100 0200 (000 110 12		t A-weighted sound pow	er level	1 14/2 0	(B)
	Idle	* System idle no stres	s. full node	Ctatiotical appoi iiiii	tri woighted deand pen	01 10 101	, -vva,c	
		configuration, and 6 P						
		chassis						
	Operation	* 100% CPU workload	and 6 PSUs installed					\boxtimes
	Otto	in chassis Declared A-weighted sound	d proceure level (dP)					
	Other mode	$L_{p \rm Am}$	r pressure lever (ub)	(operator pos	sition desktop – idle)			
	Other mode	Declared A-weighted sound $L_{p{\rm Am}}$	l pressure level (dB)	(operator pos	sition desktop – operating	1)		
	Management		ECMA 74	1				
	Measured accord	ding to: SO 7779 Other	ECMA-74 (only if not covered by	ECMA-74)				
	Electromagneti		()					
P10.4		y meets the requirement	for low frequency elect	tromagnetic fields of th	e following voluntary			
	program(s):	•		-	- ,			

NOTE B7 The following is to be excluded from the calculation of percentage: printed circuit boards, labels, cables, connectors and electronic components and postconsumer recycled plastic

NOTE B8 A Guidance document on Energy Efficiency is available; see http://www.ecma-international.org/publications/standards/Ecma-370.htm

NOTE B9 A Guidance document on Acoustic Noise is available; see http://www.ecma-international.org/publications/standards/Ecma-370.htm

Model number *		7D7N			Logo	Long		
Issue date	*	Feb 27, 2024				Leno	VO.	
Product	environr	nental attributes	- Market requirements	(continued)		Require	ment	met
Item			•	,		Yes	No	N/A
P12	Ergonoi	nics for computing	products					
P12.1*	The disp	lay meets the ergor	nomic requirements of ISO	9241-307 for visual disp	lay technologies.			\boxtimes
P12.2*	The phys	sical input device m	eets the requirements of IS	O 9995 and ISO 9241-4	·10.			\boxtimes
P13		ng and documenta						
P13.1*	Product packaging material type(s): Corrugated Double wall Product packaging material type(s): Laminated (Fabricated) EPE Cushion Product packaging material type(s): Laminated (Fabricated) EPE Bag Product packaging material type(s): Laminated (Fabricated) EPE Stretch-Wrap weight (kg): 0.08 Product packaging material type(s): Wood weight (kg): 2.993 Weight (kg): 2.993							
P13.2*			aging is free from PVC.			\boxtimes		
P13.3*	consume	er recovered fiber co			percentage of minimum	post-		
P13.4*			product documentation (ticl Other	k box):				
P13.5	Ùser and		em if paper documentatior ation on paper media is ch					
	Totally c	hlorine-free						
	Element	al chlorine-free						
	Process	ed chlorine-free						
P14	Volunta	ry programs						
P14.1	The prod	duct meets the requ	rements of the following vo	oluntary program(s):				
	Eco-labe	el:	Criteria version: 4.0 Criteria version: Criteria version:	Date: Date: Date:	Product category: Product category: Product category:			
P15		nal information (Se						
P9			mputer products; descri					
	NOTE: Supplier makes no representations, guarantees, assurances or warranties whether express or implied, regarding the information contained in this document. All information provided by supplier in this document is provided based on supplier's knowledge available at the time of completion, and supplier shall have no obligation to update such information. The information provided here is approximate and provided for informational purposes only. See a Lenovo Account Representative for more information.							
P9			Enterprise Servers for the v/products/data center		servers_			

NOTE B10 Additional lines may be inserted to declare further items, by positioning the cursor at the far right of the row and hitting the <Enter> key.

Legal references Europe Annex B2

Reference	Declaration item
Directive 2011/65/EU (RoHS Directive)* * Specific exemptions apply for certain products and applications.	P1.1, P3.1
Regulation (EC) 1907/2006 (REACH Regulation), annex XVII	P1.2, P1.4, P1.6, P1.7
Regulation (EC) 2037/2000, 2038/2000, 2039/2000 (Marketing and use of Ozone layer depleting substances)	P1.3, P5.3
Norwegian regulation relating to restrictions on the use of certain dangerous chemicals 20.12.2002	P1.5
Directive 2006/66/EC (Battery and accumulators Directive), as amended.* * These provisions shall not apply where, for safety, performance, medical or data integrity reasons, continuity of power supply is necessary and requires a permanent connection between the appliance and the battery or accumulator.	P2.1, P2.2, P2,3, P8.1
Directive 2014/35/EU (Low Voltage Directive)	P3.1
Directive 2014/30/EU (EMC Directive)	P3.1
Directive 2014/53/EU (RE Directive)	P3.1
Regulation (EC) 801/2013 amending Regulation (EC) No 1275/2008 with regard to ecodesign requirements for standby, off mode electric power consumption of electrical and electronic household and office equipment, and amending Regulation (EC) No 642/2009 with regard to ecodesign requirements for televisions	P3.1, P3.2
Commission Regulation (EC) No 278/2009 of 6 April 2009 implementing Directive 2005/32/EC of the European Parliament and of the Council with regard to ecodesign requirements for no-load condition electric power demand and average active efficiency of external power supplies	P3.1, P3.2, P9.1
COMMISSION REGULATION (EU) No 617/2013 of 26 June 2013 implementing Directive 2009/125/EC of the European Parliament and of the Council with regard to ecodesign requirements for computers and computer servers	P2.4, P2.5, P3.1, P3.2, P7.23, P9.1
Regulation (EC) No 1272/2008 (CLP Regulation)	P7.19
Directive 2004/12/EC (Packaging Directive)	P5.1
Decision 97/129/EC (Secondary packaging legislation)	P5.2
Directive 2012/19/EU (WEEE directive)	P6.1
Implementing Regulation (EU) 2019/290 establishing the format for registration and reporting of producers of electrical and electronic equipment to the register.	
Commission Implementing Regulation 2017/699 establishing a common methodology for the calculation of the weight of electrical and electronic equipment (EEE) placed on the national market in each Member State and a common methodology for the calculation of the quantity of waste electrical and electronic equipment (WEEE) generated by weight in each Member State.	

Lenovo ErP Lot9 Information Sheet - Servers & Storage Products-

As required by COMMISSION REGULATION (EU) 2019/424 of 15 March 2019 laying down ecodesign requirements for servers and data storage products pursuant to Directive 2009/125/EC of the European Parliament and of the Council and amending Commission Regulation (EU) No 617/2013. (ErP Lot9)

Products scope of this sheet: Servers & storage products

This document is only valid in connection with the IT Eco Declaration of the specific Product.

SERVERS

Genera		

Consider information						
Commercial name (3.1 (b))	ThinkSystem SD650-N V3 Neptune DWC Tray	Logo				
Contact Address (3.1 (b))	7001 Development Dr. Building 7, Morrisville, NC 27560, United					
	States		Lonovo			
Model Number (3.1 (c))	7D7N		Lenovo			
Issue Date	Feb 27, 2024		1			
Additional information						

Product e	environmental attributes (EU) 2019/424 – Annex II points 3.1 and 3.3				
1.a	Is the product consider to be in scope of ErP Lot 9 in scope out of scope, product is out of scope as:				
1.b (3.1 (a))	Server type Rack Server High Performance Computing (HPC) Tower Server Multi Node Server Blade Server Data Storage product (Please go to "DATA STORAGE PRODUCTS" section				
1.c (3.1 (d))	Year of manufacture: 2024				
1.d (3.1 (p))	Product model part of a server product family? ☐ No ☑Yes List of all model configurations that are represented by the model:				
1.e (3.1 (n))	Information on the secure data deletion functionality (a) instructions on how to use the functionality: (b) techniques used: (c) supported secure data deletion standard (if any): OR - Reference to other information:				
1.f (3.1 (o))	Blade servers? No Yes list of recommended combinations with compatible chassis: <i>ThinkSystem DW612S Neptune DWC Enclosure</i>				
Recycling	g Data				
2.a (3.3 (a))	Indicative weight range at component level, of the following critical raw materials: (a) Cobalt in the batteries (b) Neodymium in the HDDs less than 5 g between 5 g and 25 g above 25 g above 25 g				
2.b Instructions on the disassembly operations (3.3 (b)) (a) the type of operation; (b) the type and number of fastening technique(s) to be unlocked; (c) the tool(s) required.					
	OR - Reference to other information: https://datacentersupport.lenovo.com/us/en/				
2.c Firmware Reference to information on last available firmware: https://datacentersupport.lenovo.com/us/en/					
Additional	l information				

Server family specific information Family 1

Family no. / name							
Model n (3.1 (c))	umber(s) / Description		nance configuration: Processo *16, Storage: 240GB SSD*2, F	or: Intel(R) Xeon(R) Platinum 8460Y+ 40C PSU: 2600W*5			
			guration: Processor: Intel(R) 2 Storage: 240GB SSD*2, PSU: 2	Xeon(R) Platinum 8458P 44C 350W 2600W*5			
Addition	nal information						
		butes (EU) 2019/424 – Annex I	I points 3.1 and 3.3				
F1.a	PSU efficiency at 10	% (if applicable), 20 %, 50 % an	nd 100 % of rated output power				
(3.1 (e))		rounded to the first decimal place		le-output			
		performance configuration(s): 95.21% 50% 96.19% 100%	94.65% Average 95.35%				
	High-end performance configuration(s): 10% 92.87 % 20% 95.21 % 50% 96.19 % 100% 94.65 % Average 95.35 %						
F1.b (3.1 (f))							
F1.c (3.1 (g))	PSU rated power out (in Watts rounded to		standard or low-end performation: 2600	nce high-end performance configuration: 2600			
E1 d		ver product family, all PSUs offered in a server with the information specified in (e) and (f)	standard or low-end performa	nce high-end performance			
F1.d (3.1 (h))	idle state power	ed to the first decimal place)	configuration: 196.7	configuration: 199.1			
F1.e		ts for additional idle power allow		comgulation. 133.1			
(3.1 (i))	•						
		standard or configuration	low-end performance	high-end performance configuration:			
	CPU Performance		et (10 × PerfCPU W)	1 Socket			
			et (7 × PerfCPU W)	2 Socket			
lts	Additional PSU	Yes (Yes / No	,	Yes(Yes / No) #: 3			
in el	HDD	No(Yes / No)	,	No (Yes / No) #:			
Inst	SDD	Yes(Yes / No) #: 2	Yes(Yes / No) #: 2			
adj	Additional memory	Yes(Yes / No) #: 252GB	Yes (Yes / No) #: 1020GB			
ces	Additional buffered DDF	R channel Yes (Yes / No) #: 8	Yes (Yes / No) #: 8			
wan ng t	Additional I/O devices	none		none			
allo		< 1 Gb/s:	No Allowance	< 1 Gb/s: No Allowance			
/era		= 1 Gb/s:	2,0 W/Active Port	= 1 Gb/s: 2,0 W/Active Port			
wod		> 1 Gb/s a	and < 10 Gb/s: 4,0 W/Active Port	> 1 Gb/s and < 10 Gb/s: 4,0 W/Active Port			
idle power allowances adjustments during testing		≥ 10 Gb/s	and < 25Gb/s: 15,0 W/Active Port	≥ 10 Gb/s and < 25Gb/s: 15,0 W/Active Port			
-		≥ 25 Gb/s	and < 50Gb/s: 20,0 W/Active Port	≥ 25 Gb/s and < 50Gb/s: 20,0 W/Active Port			
			26,0 W/Active Port	≥ 50 Gb/s 26.0 W/Active Port			
F1.f	maximum power		standard or low-end performal				
(3.1 (j))							
F1.g	operating condition c		standard or low-end performa				
(3.1 (k))	(as defined in Table (6 or ErP lot 9)	configuration: ☐A1 ☐ A2 ☐ A3 ☐ A4	configuration: ☐A1			
			Exception comments Liquid cooling	Exception comments Liquid cooling			
F1.h (3.1 (l))	idle state power at the	state power at the higher boundary temperature standard or low-end performance high-end performance configuration: 201.7 high-end performance					
F1.i		ency and the performance in	standard or low-end performal				
(3.1 (m))	active state of the se		configuration: 48.9	configuration: 53.8			